

Electronic Patent Application Fee Transmittal

Application Number:				
Filing Date:				
Title of Invention:	MULTIPLE STACKED DIE WINDOW CSP PACKAGE AND METHOD OF MANUFACTURE			
First Named Inventor:	Chuen Khiang WANG			
Filer:	Leslie J. Paperner/Ayako Asada			
Attorney Docket Number:	P26634			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
National Stage Fee	1631	1	300	300
Natl Stage Search Fee - Report provided	1642	1	400	400
National Stage Exam - all other cases	1633	1	200	200
Pages:				
Claims:				
Claims in excess of 20	1615	11	50	550
Miscellaneous-Filing:				
Petition:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				1450